NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE2006NE uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

General Features

● V_{DS} = 20V,I_D =7A

 $R_{DS(ON)}$ < 27m Ω @ V_{GS} =2.5V

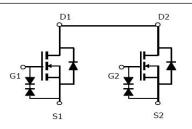
 $R_{DS(ON)}$ < 21m Ω @ V_{GS} =4.5V

ESD Rating: 2000V HBM

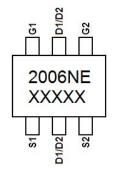
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

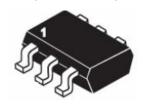
- ●PWM application
- Load switch



Schematic diagram



Marking and pin assignment



SOT23-6L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2006NE	NCE2006NE	SOT23-6L	Ø180mm	8mm	3000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage ^(Note5)	V _G s	±12	V
Drain Current-Continuous	I _D	7	Α
Drain Current-Pulsed (Note 1)	I _{DM}	30	Α
Maximum Power Dissipation	P _D	1.25	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	100	°C/W

NCE2006NE

Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	20		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V,V _{DS} =0V	-	-	±10	μA
On Characteristics (Note 3)			,			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	0.5	0.7	1.0	V
Danier Courses On Otata Banistana		V _{GS} =4.5V, I _D =6.5A	-	15	21	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =2.5V, I _D =5.5A	-	20	27	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =7A	-	20	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	Clss		-	800	-	PF
Output Capacitance	Coss	$V_{DS}=10V, V_{GS}=0V,$	-	150	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	140	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	6		nS
Turn-on Rise Time	t _r	V_{DD} =10 V , R_L =1.35 Ω	-	13		nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =5 V , R_{GEN} =3 Ω	-	52		nS
Turn-Off Fall Time	t _f		-	16		nS
Total Gate Charge	Qg	\/ 40\/1 74	-	12.5		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=10V,I_{D}=7A,$	-	1.3	-	nC
Gate-Drain Charge	Q_{gd}	V_{GS} =4.5 V	-	3.5	-	nC
Drain-Source Diode Characteristics				•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =1A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	7	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production
- 5. Gate-Source Voltage (max) Test condition: $V_{\text{GD}}\text{=}0V~I_{\text{S}}\text{=}\pm1\text{mA}$



Typical Electrical and Thermal Characteristics

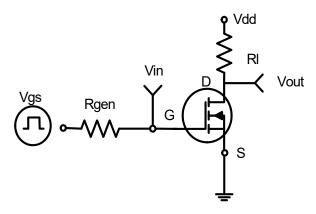


Figure 1:Switching Test Circuit

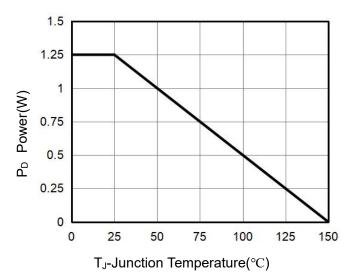


Figure 3 Power Dissipation

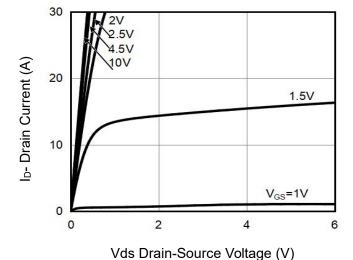


Figure 5 Output Characteristics

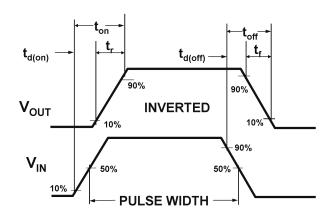


Figure 2:Switching Waveforms

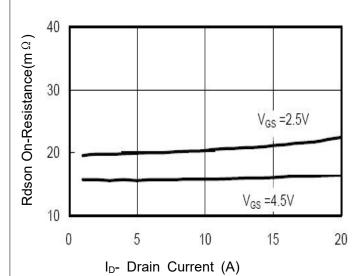


Figure 6 Drain-Source On-Resistance

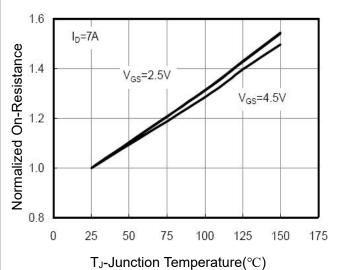
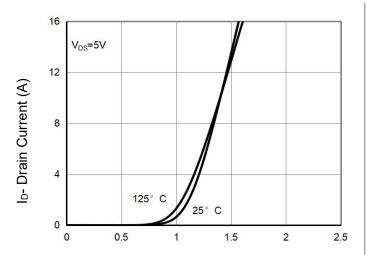


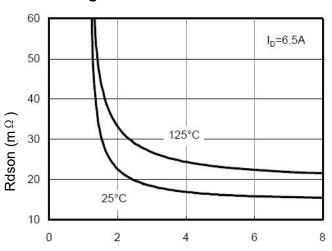
Figure 8 Drain-Source On-Resistance





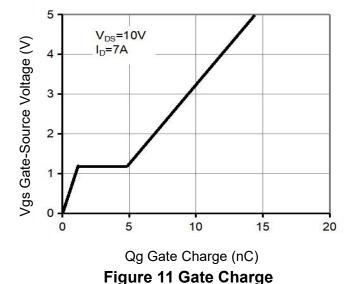
Vgs Gate-Source Voltage (V)

Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs



1600 1400 1200 Ciss 1000 Coss Coss Crss

Vds Drain-Source Voltage (V)

5

0



10

15

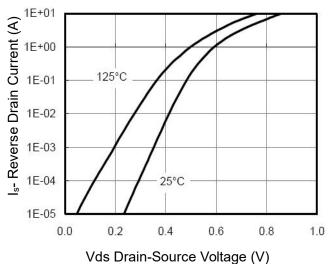


Figure 10 Capacitance vs Vds

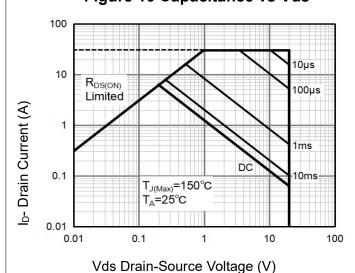
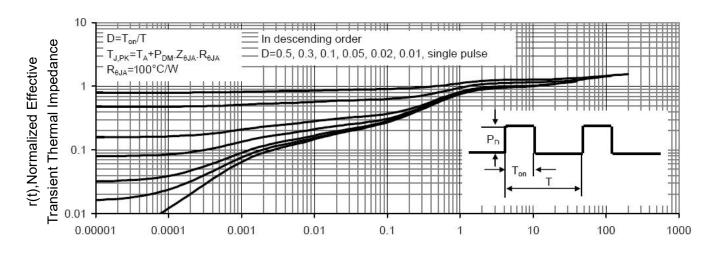


Figure 13 Safe Operation Area



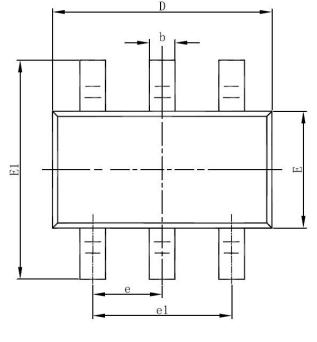


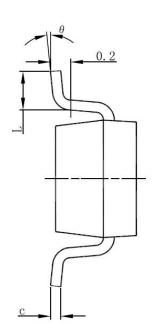
Square Wave Pluse Duration(sec)

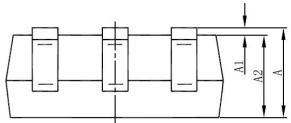
Figure 14 Normalized Maximum Transient Thermal Impedance



SOT23-6L Package Information







Ch l	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950(BSC)		0.037(BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

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NCE2006NE

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